Sensera Limited AGM Meeting

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Sensera MEMS (Micro Electro Mechanical Systems) Structures to Full Sensors

Primary Market: Medtech



\$1B MEMS TAM 9% AGR

► FY20 added \$2B in

TAM in optical applications



What Sensera Delivers

- ► Custom semiconductor-based products designed, developed and manufactured
- Microfluidics and light sensing expertise

Our Customer's Products

Point of Care

- ▶ Blood Monitor
- ▶ Heart Pump
- ▶ Nebulizer



Lab-on-a-Chip / Organ-on-a-Chip



Sensera[®]

Over 25 custom designs in fluidics and light sensors, shipped in tens of thousands

About Sensera

- ► A developer and manufacturer of Micro Electro Mechanical Systems (MEMS) based IOTsensors
- ► One core business unit in Boston, MA USA addressing this capability
 - ► MicroDevices = MEMS based structures and sensors
 - ► Fab = Semiconductor based MEMS cleanroom-based manufacturing
 - ► Micro-assembly = Manual assembly of MEMS microstructures in sensor packaging
- ► Proven technology in various high-volume applications
 - ► Over 25 custom designs in fluidics and light sensors, shipped in tens of thousands



Sensera: Recent Events and Current Situation

- ► Sensera sold its IOT Solutions Business to Inpixon in October for US\$8.7m
 - ► Core debt and Notes retired with proceeds of cash from sale
 - ► Company cash position improved to US\$1.4m in October
- ▶ New opportunity pipeline full at MicroDevices (i.e. MEMS) division
 - ► Team has been fully operational on-site through the pandemic
 - ► More significant opportunities progressed then stalled due to COVID ramifications
- ► MicroDevices division operating profitably for the last 2 quarters
 - ▶ Breakeven lowered to US\$1.35m and was further lowered temporarily due to pay reductions
 - ▶ Will dip back negatively in FQ2 due to production transitions; expect revenue growth for the year
- ▶ Board reduction finalized in October
- ► Further corporate cost reductions to be delivered through the balance of FY21



Our Strategy and Progress

- ▶ Build a profitable component level business based on unique MEMS based sensors
- ► Fill the niche of high value MEMS foundry solutions for mid-tier customers
 - ► Customer funds most of the development with contracted engineering and in-house manufacturing
 - ► FY20: Moved from mostly R&D solutions to product-based engagements
 - ► Leverage IP developed to our own sensors by FY22
 - FY20: Slowed development of Infrared Gas Sensors to be done as a Joint Venture



P&L Overview

US\$M	FY 20	FY 19	FY 18
Revenues	11.8	10.2	6.4
Cost of Sales	(6.1)	(6.0)	(3.1)
Gross Profit	5.7	4.2	3.3
GM%	48%	41%	52%
Operational Overheads & Admin			
Employee Costs	(4.1)	(6.5)	(4.5)
Fab Equip, Occupancy	(1.0)	(1.9)	(1.0)
Ops Consultants	(0.3)	(0.8)	(8.0)
Other Expenses	(2.3)	(1.7)	(2.1)
Subtotal Operational Overheads	(7.7)	(10.9)	(8.4)
Sales & Marketing	(1.6)	(1.4)	(0.4)
R&D	(0.2)	(1.3)	(1.2)
Total Operating Expenses	(9.5)	(13.6)	(10.0)
Underlying Loss	(3.7)	(9.4)	(6.7)
Restructure Expenses	(1.2)	-	-
Impairment of Goodwill	(1.9)	-	-
Finance Expenses (interest, fees)	(0.9)	(0.1)	-
Finance cost of debt (warrants, net)	(8.0)	-	-
Tax Benefit	0.1		
Net Loss	(8.3)	(9.5)	(6.7)

- ▶ Slowdown in revenue in 2H FY20 as 58% recorded in 1H
- ➤ 7% YoY GM improvement due to manufacturing cost improvements
 - Excessive supply chain costs due to capital constraints and early ramps
 - ► Lower Margin contract expired mid FY20
- ▶ Operating expenses lowered over 30% in second half of FY 20
- ► FY20 underlying operating losses improved by \$5.6m

► Net loss driven by restructuring, goodwill impairment of IOTS and debt expenses

Cash Flow

	FY 20 US\$M	FY 19 <u>US\$M</u>	FY 18 <u>US\$M</u>
Cash Flows from operating activities			
Receipts from customers	12.4	9.2	5.5
Payments to suppliers and employees	(16.1)	(17.4)	(11.7)
Government grants - Covid-19	0.7		
Net cash (outflow) from operating activities	(3.1)	(8.2)	(6.2)
Cash flows from investing activities			
Payments for Nanotron acquisition	-	(2.2)	(4.2)
Payments for fixed assets	(0.1)	(0.4)	(1.3)
Proceeds from sale of fixed assets	-	-	1.1
Payments for software development	(0.1)	(0.6)	
Net cash (outflow) from investing activities	(0.2)	(3.2)	(4.4)
Cash flows from financing activities			
Proceeds from issues of shares (net of cost)	2.0	8.0	8.4
Proceeds from borrowings	4.8	2.5	-
Interest paid	(0.4)	(0.1)	-
Repayment of borrowings	(2.0)		
Lease repayments	(0.6)		
Net cash inflow from financing activities	3.8	10.4	8.4

► Cash Collections grew 35%

► PPP and KUG Grants to offset payroll and lowered outflow of cash

- ► Closed debt financing in FY20 and paid off in Q1 FY21
- ► Fab equipment lease repayment started in Q4 FY20



Balance Sheet

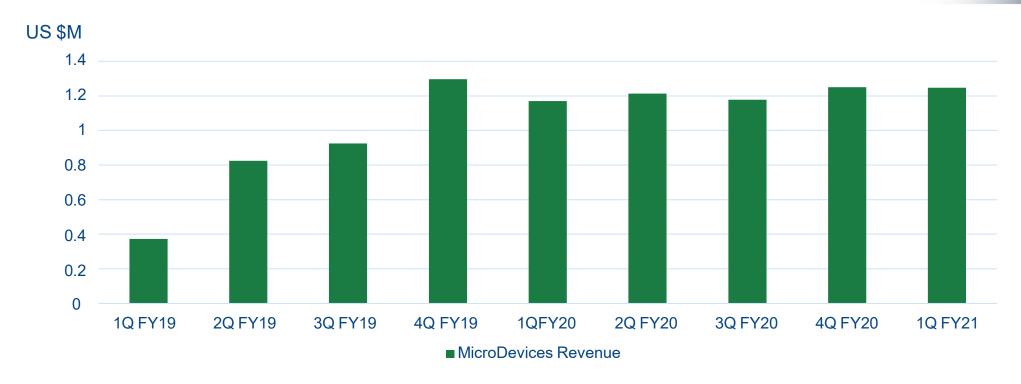
_	FY 20 US\$M	FY 19 US\$M	FY 18 US\$M
Cash	1.4	8.0	2.0
Trade Receivables	0.9	2.0	1.0
Inventory and Other	1.3	<u>1.5</u>	1.2
Current Assets	3.6	4.3	4.2
Fixed Assets	10.3	10.4	9.8
Total Assets	13.9	14.7	14.0
Accounts Payable	1.6	3.0	3.6
Borrowings	5.1	2.5	-
Other Liabilities	5.6	2.2	2.1
Total Liabilities	12.3	7.7	5.7
Net Assets	1.6	7.0	8.3
Share Capital & Reserve	31.2	28.5	20.4
Accumulated Losses	(29.6)	(21.5)	(12.1)
Total Equity	1.6	7.0	8.3

- ► Inventory tightened as the market demand reduced in 2nd half of FY20
- ► Leasing of equipment minimized fixed asset investment

- ▶ Other Liabilities
 - ► Lease liabilities of US\$1.9m (accounting change)
 - ► PPP loan of US\$620k
 - ► Warrant liabilities of US\$1.2m



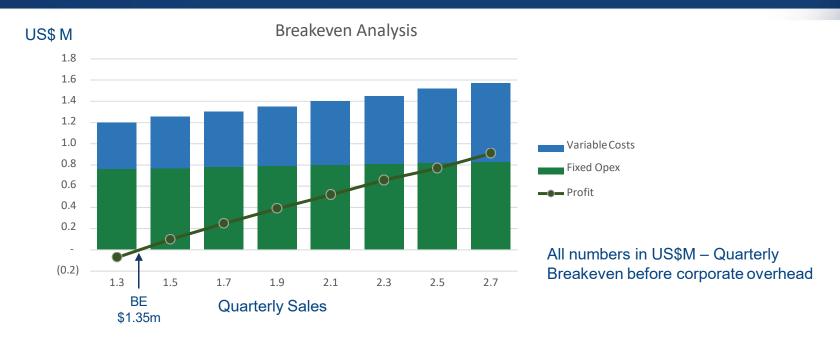
MicroDevices Revenue



- ▶ 41% Revenue growth in FY20 through new customer engagements filled 2nd half reduction
 - ► Abiomed business down 15% in 2nd half FY20 due to bench production reduction Sensors and new projects grew
 - ► Mostly replaced with COVID sensor development charges and multiple other customer development related revenue



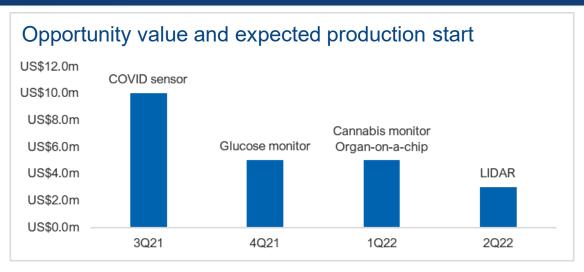
MicroDevices - Breakeven and Operational Leverage



- Manufacturing is performed in our MEMS fabrication facility and sensor micro assembly facility
 - ► High level of fixed fab cost currently underutilized at 30%
- ► Fabrication facility is shared with another company = keeps capex low as some equipment is procured and shared with partner
- ▶ MicroDevices break even before corporate overhead improved further in FY20 from US\$1.75m to US\$1.35m per quarter
- ▶ Product cost improvements realized by bringing all processes in-house during FY20



Pipeline growth due to movement to end product-based designs



Committed pipeline is not contracted but customer guidance of total demand. Any revenue will be booked over several periods or years from the expected start date.

- ▶ Movement away from Non-Recurring Engineering (NRE) based engagements to actual end product-based designs. Now possible due to the maturity of the fab facility and employing ISO based processes for volume manufacturing.
- ▶ Two multimillion \$ customers expected to start production ramp in FY21 one currently in qualification phase
- Some delays due to COVID related customer team availability and priorities most back on-board as of October
- ► Total pipeline of late-stage customer work is US\$24.0m
- ▶ Nine current customers in development through pre-production
 - ▶ COVID Sensor
 - ▶ Glucose Monitoring
 - ► Organ-on-a-chip / Lab-on-a-chip
 - Cannabis Gas Monitoring
 - ► LIDAR Vision System
- ► Four other customers in early pipeline



Sensera Outlook

- ► Expect FY21 revenue to grow due to the movement of customers from development to production
- ► Improved yearly operational performance due to higher level of fab related manufacturing output
- ► Expect FQ2 to see programs transition and year end customer inventory adjustments resulting in revenue likely to be under US\$1M
- ► COVID sensor not yet submitted for Emergency Use Authorization (EUA) through the US Food and Drug Association (FDA). Company still expects to ramp this product throughout the balance of FY21.
- ► Continued evaluation and execution of cost reductions primarily in corporate costs and structure
- ► Driving increased scale through strategic partnerships



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